SDLS026

SN5401, SN54LS01, SN7401, SN74LS01 QUADRUPLE 2-INPUT POSITIVE-NAND GATES WITH OPEN-COLLECTOR OUTPUTS

APRIL 1985 - REVISED MARCH 1988

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

description

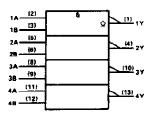
These devices contain four independent 2-input NAND gates. The open-collector outputs require pull-up resistors to perform correctly. They may be connected to other open-collector outputs to implement active-low wired-OR or active-high wired-AND functions. Open-collector devices are often used to generate higher VOH levels.

The SN5401 and SN54LS01 are characterized for operation over the full military temperature range of -55°C to 125°C. The SN7401 and SN74LS01 are characterized for operation from 0°C to 70°C.

FUNCTION TABLE (each gate)

INP	UTS	OUTPUT
A	В	Y
н	н	L
L	Х	н
×	L	н

logic symbol[†]



[†]This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

APRIL 1985 - REVISE
SN5401 J PACKAGE SN54LS01 J OR W PACKAGE SN7401 N PACKAGE SN74LS01 D OR N PACKAGE (TOP VIEW)
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$
SN5401 W PACKAGE (TOP VIEW)
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$
SN54LS01 FK PACKAGE (TOP VIEW)
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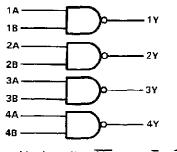
NC - No internal connection

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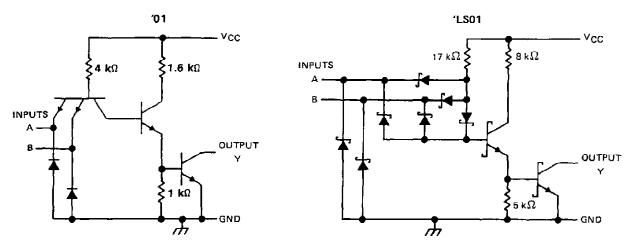
SN5401, SN54LS01. SN7401, SN74LS01 QUADRUPLE 2-INPUT POSITIVE-NAND GATES WITH OPEN-COLLECTOR OUTPUTS

logic diagram (positive logic)



positive logic; Y = $\overline{A \cdot B}$ or Y = $\overline{A} + \overline{B}$

schematics (each gate)



Resistor values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1): '0	D1, ′LSO1	7 V
Off-state output voltage		7 V
	SN54'	
	SN74′	0°C to 70°C
Storage temperature range		5°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminals.



SN5401, SN7401 QUADRUPLE 2 INPUT POSITIVE NAND GATES WITH OPEN-COLLECTOR OUTPUTS

recommended operating conditions

			SN5401			SN7401			
		MIN	NOM	ΜΑΧ	MIN	NOM	мах	UNIT	
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V	
VIH	High-level input voltage	2			2			v	
ViL	Low-level input voltage			0.8			0.8	V	
∨он	High-level output voltage			5.5			5,5	v	
IOL	Low-level output current			16			16	mΑ	
Тд	Operating free-air temperature	- 55		125	0		70	°C	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS [†]	SN5401	SN7401	
	TEST CONDITIONS.	MIN TYP [‡] MAX	MIN TYP [‡] MAX	UNIT
Vik	$V_{CC} = MIN, I = -12 mA$	- 1.5	- 1.5	v
1	$V_{CC} = MIN, V_{IL} = 0.8 V, V_{OH} = 5.5 V$		0.25	^
юн	VCC = MIN, VIL = 0.7 V, VOH = 5.5 V	0.25		mΑ
VOL	V _{CC} = MIN, V _{IH} = 2 V, I _{OL} = 16 mA	0.2 0.4	0.2 0.4	V
4	VCC = MAX, VI = 5.5 V	1	1	mΑ
ΪН	$V_{CC} = MAX, V_{I} = 2.4 V$	40	40	μA
ηĽ	$V_{CC} = MAX, V_I = 0.4 V$	-1.6	- 1.6	mА
ССН	$V_{CC} = MAX, \forall_{ } = 0$	4 8	4 8	mΑ
ICCL	$V_{CC} = MAX, V_{\parallel} = 4.5 V$	12 22	12 22	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. [‡]All typical values are at $V_{CC} = 5 V$, $T_A = 25 °C$.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	MIN	TYP	МАХ	UNIT	
TPLH	A or B	v	RL=4kΩ,	CL = 15 pF		35	55	ns
^t PHL	7015		R _L = 400 Ω,	CL = 15 pF		8	15	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

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SN54LS01, SN74LS01 QUADRUPLE 2-INPUT POSITIVE-NAND GATES WITH OPEN-COLLECTOR OUTPUTS

recommended operating conditions

		SN54LS01			SN74LS01			
	MIN	NOM	MAX	MIN	NOM	МАХ		
V _{CC} Supply voltage	4,5	5	5.5	4.75	5	5.25	V	
VIH High-level input voltage	2			2			V	
VIL Low-level input voltage			0.7		····	0.8	v	
VOH High-level output voltage			5.5			5.5	V	
IOL Low-level output current			4			8	mА	
T _A Operating free-air temperature	- 55		125	0		70	°c	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	ł	TEST CONDI		SN54LS	01					
PARAMETER		TEST CONDI	TIONS	MIN	TYP‡	МАХ	MIN	TYP‡	МАХ	
VIK	V _{CC} = MIN,	lj = ~ 18 mA				- 1.5			- 1.5	V
юн	V _{CC} = MIN,	V _{IL} = MAX,	V _{OH} = 5.5 V			0.1			0.1	mΑ
14	Vcc = MIN,	V _{IH} = 2 V,	IQL = 4 mA		0.25	0.4		0.25	0.4	v
V _{OL}	Vcc = MIN,	V _{IH} ≈ 2 V,	IOL = 8 mA					0.35	0.5	1 °
4	V _{CC} = MAX,	V ₁ = 7 V				0.1	1		0.1	mA
Чн	V _{CC} = MAX,	V ₁ = 2.7 V				20	1		20	μA
ηΓ	V _{CC} = MAX,	V ₁ = 0.4 V				- 0.4			- 0.4	mA
ICCH	VCC = MAX,	VI = 0			0.8	1.6		0.8	1.6	mΑ
ICCL	V _{CC} ≠ MAX,	V ₁ = 4.5 V			2.4	4.4		2.4	4.4	mA

 \uparrow For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. \ddagger All typical values are at V_{CC} = 5 V, T_A = 25°C.

switching characteristics, V_{CC} = 5 V, T_A = 25° C (see note 2)

PARAMETER	FROM (INPUT)	TO {OUTPUT}	TEST CONDITIONS	MIN	TYP	МАХ	UNIT
tPLH	A or B	Y	RL=2 kΩ, CL=15 pF		17	32	nş
[‡] PHL					15	28	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.





PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN5401J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN5401J	Samples
SN54LS01J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS01J	Samples
SN54LS01J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS01J	Samples
SNJ5401J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ5401J	Samples
SNJ5401J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ5401J	Samples
SNJ5401W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ5401W	Samples
SNJ5401W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ5401W	Samples
SNJ54LS01J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS01J	Samples
SNJ54LS01J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS01J	Samples
SNJ54LS01W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS01W	Samples
SNJ54LS01W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS01W	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.



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PACKAGE OPTION ADDENDUM

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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TEXAS INSTRUMENTS

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TUBE



- B - Alignment groove width

*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
SNJ5401W	W	CFP	14	1	506.98	26.16	6220	NA
SNJ54LS01W	W	CFP	14	1	506.98	26.16	6220	NA

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only.
 - E. Falls within MIL STD 1835 GDFP1-F14



GENERIC PACKAGE VIEW

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



J0014A



PACKAGE OUTLINE

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
 Falls within MIL-STD-1835 and GDIP1-T14.



J0014A

EXAMPLE BOARD LAYOUT

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE





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